# F&eIT Series Isolated Digital Input Module DI-32(FIT)GY



\* Specifications, color and design of the products are subject to change without notice.

# Features

A different external power supply can be used for each common pin as it is shared by 16 signal points.

This product can perform 32-points digital signal input. Input section is ready to accept both the current sinking output and current source output.

Isolated input operations using an optocoupler improves noise immunity.

This product has a digital filter to prevent input signals from carrying noise or a chattering.

A rotary switch allows you to set device IDs, making it easy to keep track of device numbers.

Like other F&eIT series products, the module has a 35mm DIN rail mounting mechanism as standard. A connection to a controller module can be effected on a lateral, stack basis in a unique configuration, which permits a simple, smart system configuration without the need for a backplane board.

You can use all of the input signals as interrupt inputs. You can also select the interrupt trigger edge of the input signal.

#### **Included Items**

Module [DI-32(FIT)GY] ...1 Please read the following ... 1 Interface connector plug ...1 This product is an expansion module (device module) that adds digital signal I/O interfaces to one of various types of controllers. The product is used in combination with the I/O controller module

- < CPU-CAxx(FIT)GY > (\*1) or BOX-PC < BX-300-DC5xxx > (\*1) or microcontroller unit
- < CPU-SBxx(FIT)GY > (\*1) in the F&eIT Series.

This product can perform a maximum of 32 points of optoisolated input per module. (Input: 12 - 24 VDC specified)

- \*1 This module is available in different product models. "X" in each model number represents a blank or one alphanumeric character. This is applicable to the rest of this document.
- \* The contents in this document are subject to change without notice.
- \* Visit the CONTEC website to check the latest details in the document.
- \* The information in the data sheets is as of July, 2024.

### **Specifications**

#### **Function specification**

ltem	Specifications					
Input section						
Input format	Opto-isolated input					
	(compatible with current sink output and current source output)					
Input resistance	3kΩ					
Input ON current	3.4 mA or more					
Input OFF current	0.16 mA or less					
Number of input signal points	32 points (16 points/common)					
Response time	Within 1msec					
External circuit power supply	12 - 24 VDC (±15%)					
	(4 mA/12V - 8 mA/24V per channel)					
Common section						
Interrupt level	Using BX-300-DC5xxx or CPU-SBxx(FIT)GY: IRQ 5, 7, or 9					
External circuit power supply	12 - 24 VDC (±15%)					
Internal current consumption	5 VDC(±5%) 150 mA(Max) *1					
Allowable distance of signal extension	Approx. 50m (depending on wiring environment)					
Physical dimensions (mm)	25.2(W) x 64.7(D) x 94.0(H) (exclusive of protrusions)					
Weight of the module itself	100g					
Module connection method	Stack connection by means of a connection mechanism standard with the					
	system					
Module installation method	One-touch connection to 35mm DIN rails					
	(standard connection mechanism provided in the system)					
Applicable wire	AWG24 - 16					
Applicable plug	FMC 1,5/18-ST-3,5(made by Phoenix Contact Corp.)					

<sup>\*1</sup> The stack connector accepts currents of up to 3.0A (Max).

#### **Installation Environment Requirements**

ltem		Requirement description				
Operating temperature		0 - 50℃				
Storage temperature		-10 - 60°C				
Operating humidity		10 - 90%RH (No condensation)				
Floating dust particles		Not to be excessive				
Corrosive gases		None				
Noise immunity	Line-noise *1	AC line/2kV, Signal line/1kV (IEC1000-4-4Level 3, EN61000-4-4Level 3)				
	Static electricity resistance	Contact discharge/4kV (IEC1000-4-2Level 2, EN61000-4-2Level 2) Atmospheric discharge/8kV (IEC1000-4-2Level 3, EN61000-4-2Level 3)				
Vibration resistance	Sweep resistance	10 - 57Hz/semi-amplitude 0.15mm, 57 - 150Hz/2.0G 80minutes each in X, Y, and Z directions UIS C0040-compliant, IEC68-2-6-compliant)				
Impact resistance		15G half-sine shock for 11ms in X, Y, and Z directions (JIS C0041-compliant, IEC68-2-27-compliant)				
Standard		FCC Class A, VCCI Class A, CE Marking (EMC Directive Class A, RoHS Directive), UKCA				

<sup>\*1</sup> When using a POW-AD22GY

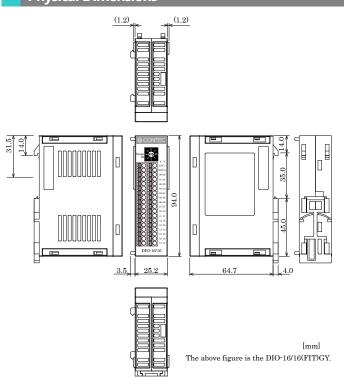
#### **∴** CAUTION

When connecting one of the modules to a controller module, the internal current consumption should be taken into account. If the total current exceeds the capacity of the power supply unit, the integrity of the operation cannot be guaranteed. For further details, please see the Controller Module manual.

DI-32(FIT)GY

# Interface Connector IN00 - IN07 Interface Connector IN10 - IN17 Interface Connector IN20 - IN27 Interface Connector IN30 - IN37 Opto-Coupler Tri-State Buffer Control Circuit Device ID

# **Physical Dimensions**



# Functions and control method by controller connected

This product can be connected to a variety of controllers.

#### Supported controllers

BOX-PC : BX-300-DC5xxx Microcontroller Unit : CPU-SBxx(FIT)GY I/O Controller Module : CPU-CAxx(FIT)GY

Monitoring & Control Server Unit : SVR-MMF2(FIT)

Check each controller to which the module can be connected as well as the method of controlling the module when connected to that controller.

#### Connections to controllers

O: Permitted ×: Not permitted	BX-300, 7	CPU-SP	CPU-CA	SVR:MA.	SVR:MAS	AD(ULID)OTO
DIO-16/16(FIT)GY	0	О	0	0	×	
DI-32(FIT)GY	0	0	0	0	×	
DO-32(FIT)GY	0	О	О	О	×	
Device ID setting range	0 - 7	0 - 7	0 - 7	0 - 7	0 - 7	Ī

#### Control method by controller connected

		BX-300-5	CPU-SP	AD(ALIA)SOC	SVR:300.5	SVR:MA.	AD(ala))ahar
Control using the I/O address map			0				
Control using the memory address map				О			1
Control via the Windows driver *	FIT Protocol			О			
	API-CAP(W32)			О			1
	API-SBP(W32)	0	О				1
	API-USBP(WDM)						
Control over the web (as set from within the browser)					0		

<sup>\*</sup> The API-SBP(W32) is included in the development kit [DTK-SBxx(FIT)GY]; the other drivers are bundled with each controller.

#### Control using the I/O address map

When connected to the BX-300-DC5xxx, the CPU-SBxx(FIT)GY, the module can receive I/O instructions directly from the controller module.

#### Control using the memory address map

When connected to the CPU-CAxx(FIT)GY, the module can be accessed from the host computer over the network. The module is assigned with its device ID in the memory managed by the controller module. The application running on the host computer controls the module by reading/writing the memory managed by the controller module.

#### Control via the Windows driver

For the functions and settings available when using the Windows driver, refer to the reference manual and online help for each module.

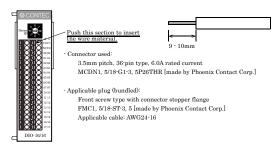
#### Control over the web - Connecting to the SVR-MMF2(FIT)

You can monitor collected data and manage the log over the web. You can use your familiar browser to easily make various settings. For details, refer to the reference manual for the SVR-MMF2(FIT).

# **How to Connect an Interface Connector**

When connecting the Module to an external device, you can use the supplied connector plug.

When wiring the Module, strip off approximately 9 - 10mm of the covering for the cable, and insert the bare wire by pressing the orange button on the connector plug. Releasing the orange button after the wire is inserted fixes the cable. Compatible wires are AWG 24 - 16.





Removing the connector plug by grasping the cable can break the wire.

DI-32(FIT)GY

# **Signal Layout on the Interface Connector**

The Module can be connected to an external device using two 18-pin connectors that is provided on the Module face.

x	Pin No.	Signal name	Meaning	ı	Pin No.	Signal name	Meaning
C0 C1	Х		•		Х		
NCNC 00 20 01 21	CO	СОМ	Common for Input+0, +1 group		C1	COM	Common for Input+2, +3 group
	NC	N.C.	Unconnected		NC	N.C.	Unconnected
1 Q 1 Q 02 22 02 22	00	IN00			20	IN20	
03 23	01	IN01			21	IN21	
111Q 111Q 04 24	02	IN02			22	IN22	
05 25	03	IN03	Input+0 group		23	IN23	Input+2 group
06 26	04	IN04	ii ipat+o group		24	IN24	iiiput+2 gioup
07 27	05	IN05			25	IN25	
10 30	06	IN06			26	IN26	
	07	IN07			27	IN27	
	10	IN10			30	IN30	
	11	IN11			31	IN31	
13 33	12	IN12			32	IN32	
14 34 III	13	IN13	Input+1 group		33	IN33	Input+3 group
15 35 III	14	IN14	input+1 group		34	IN34	iiiput+3 gioup
16 36	15	IN15			35	IN35	
17 37	16	IN16			36	IN36	
	17	IN17			37	IN37	

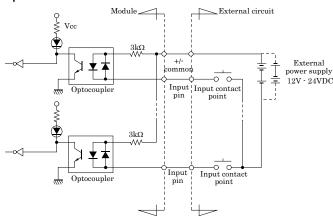
# **External Input Circuits**

#### Input section

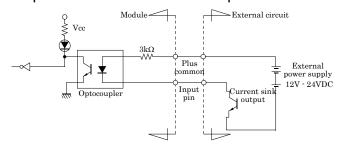
Figure below shows the input equivalent circuit for the interface section of this product.

The signal input section consists of an opto-isolated input (compatible with both current sink output and current source output). An external power supply is therefore required to drive the input section of this module. The power requirement for this product is about 8 mA per input channel at 24 VDC (about 4 mA at 12 VDC).

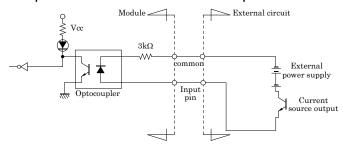
#### Input Circuit



#### **Example of a Connection to Current Sink Output**

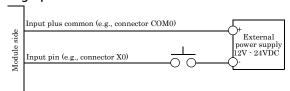


#### **Example of a Connection to Current Source Output**

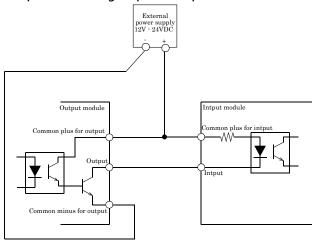


#### Connection example:

#### Using Inputs X0



#### **Example of Connecting Outputs and Inputs**



# **Setting a Device ID**

The controller module distinguishes and keeps track of the modules that are connected to it by assigning device IDs to them. Each module, therefore, should be assigned a unique ID.

A Device ID can be assigned in a 0 - 7 range, so that a maximum of eight modules can be distinguished.

The factory setting for the Device ID is [0].

#### Setup Method

A Device ID can be set by turning the rotary switch that is located on the module face.

A Device ID can be assigned by turning the switch.

